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# Polymer PTC Devices

Surface mount fuses

Shanghai Wayon Thermo/Electro Materials Co.,Ltd.

4th Floor, No.201, New Jinqiao Road, Shanghai 201206,China Tel: 86-21-50320161 58995165 Fax: 86-21-50320266

Http://www.way-on.com



# Features

LM130

- □ Surface mount devices
- □ Withstanding high interrupt voltage
- ☐ Agency Recognition: UL、CSA、TUV

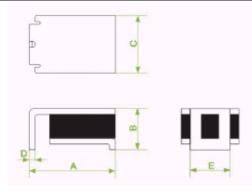




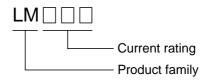
#### **Product Dimensions (mm)**

Part number	Α	В	С	D	Е
	Max	Max	Max	Min	Тур
LM130	9.4	3.4	7.4	0.3	3.8

E-mail: market@way-on.com



# Marking system



- \* Terminal materials: Tin-plated brass.
- Lead-free devices are available,
  the right logo is lead-free mark of wayon.



### **Electrical Characteristics**

Part number _	l <sub>Η</sub>	I <sub>T</sub> T <sub>trip</sub>			V <sub>max</sub>	I <sub>max</sub>	Pd <sub>typ</sub>	$R_{\text{min}}$	$R_{\text{max}}$
	(A)	(A)	Current(A)	Time(S)	(V)	(A)	(W)	( )	( )
LM130	0.130	0.260	1.00	0.90	250	3.0	3.00	6.5	12.0

I<sub>H</sub>=Hold current: maximum current at which the device will not trip at 25 still air.

I<sub>T</sub>=Trip current: minimum current at which the device will always trip at 25 still air

T<sub>trip</sub>=Typical time to trip(s) at assigned current.

V<sub>max interrupt</sub>=Maximum interrupt voltage device can withstand without damage at rated current.

I<sub>max</sub>=Maximum fault current device can withstand without damage at rated voltage.

 $Pd_{typ}$ =Typical power dissipation: typical amount of power dissipated by the device when in state air environment.

R<sub>min</sub>=Minimum device resistance at 25 prior to tripping.

R<sub>max</sub>=Maximum device resistance at 25 prior to tripping.

## Thermal Derating Chart-I<sub>H</sub>(A)

Part number			Maxim	um ambien	t operating	temperatu	ıres( )		
	-40	-20	0	25	40	50	60	70	85
LM130	0.208	0.182	0.156	0.130	0.104	0.091	0.078	0.065	0.045

### **Package Information**

Bulk: 1000pcs per bag.

Tape & Reel: 1500pcs per reel.